504843673 03/29/2018

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
NURUL NADIAH MANAP	03/29/2018
SHUTESH KRISHNAN	03/29/2018
SOON WEI WANG	03/29/2018

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC
Street Address:	5005 E. MCDOWELL ROAD
Internal Address:	MAILDROP A700
City:	PHOENIX
State/Country:	ARIZONA
Postal Code:	85008

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15939843

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ATTORNEY DOCKET NUMBER:	ONS02716US
NAME OF SUBMITTER:	SHARRON CASTILLO
SIGNATURE:	/Sharron Castillo/
DATE SIGNED:	03/29/2018

Total Attachments: 2

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PATENT REEL: 045386 FRAME: 0384 504843673

ASSIGNMENT & AGREEMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we,

Name of (City and State OR Country)

NURUL NADIAH MANAP SEREMBAN MALAYSIA
SHUTESH KRISHNAN SEREMBAN MALAYSIA
SOON WEI WANG SEREMBAN MALAYSIA

agree to sell, assign, and transfer, and do hereby sell, assign, and transfer to Semiconductor Components Industries, LLC, a limited liability company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives ("SCI"), the entire right, title, and interest in and to the inventions and discoveries as described, illustrated, and/or claimed in

Title: ULTRA-THIN MULTICHIP POWER DEVICES

Attorney Docket No.: ONS02716US

Serial No.: 15/939843

Filing Date: March 29, 2018

together with the entire right, title, and interest in and to the above listed application(s), and in and to any and all provisional, non-provisional, divisional, continuation, continuation-in-part, international, foreign, and any and all other applications related thereto, and also including any and all grants, issuances, letters patent, reissues, reexaminations, renewals, priority rights, and priority claims related to any of the foregoing, and any and all rights to collect past damages for infringement of any of the foregoing (the "Patent Rights").

We further authorize SCI to apply for and hold and maintain the Patent Rights throughout the world directly in its own name or any other name which SCI deems appropriate in its sole discretion, and to claim the priority of the filing date of the above listed application(s).

We agree that, when requested, we will, without charge to SCI, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing, maintaining, and enforcing the Patent Rights in any and all countries and for vesting title thereto in SCI or its nominees.

We represent and warrant that we have full right to convey the entire right, title and interest herein sold, assigned, and transferred, and that the Patent Rights hereby conveyed are free from all prior assignment, grant, mortgage, license, or other encumbrance to anyone other than SCI. We covenant and further warrant that we will not convey hereafter any part of the Patent Rights to anyone other than SCI or do any act whatsoever conflicting with this ASSIGNMENT & AGREEMENT.

We hereby authorize SCI or anyone it may properly designate to insert in this ASSIGNMENT & AGREEMENT the filing date and serial number of the above listed application(s) when ascertained. More than one counterpart of this ASSIGNMENT & AGREEMENT may be executed, each of which will be deemed an original.

PATENT REEL: 045386 FRAME: 0385

By (Inventor signature):	
Nurul Nadiah Manap	
Witnessed by (Witness signature):	
Printed name of Witness: CHEW YING HEONG	:
Signed and Witnessed on (date): 29 MARCH 2018	:
By (Inventor signature): Shutesh Krishnan	
Witnessed by (Witness signature):	
Printed name of Witness: CHIEW YING HEDNG	:
Signed and Witnessed on (date): 39 MAYLY 2018	
By (Inventor signature):	
Witnessed by (Witness signature):	
Printed name of Witness: <u>শোহমে মুমের্ছ পটেমব্র</u>	
Signed and Witnessed on Idahah BA MARIH 2016	

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